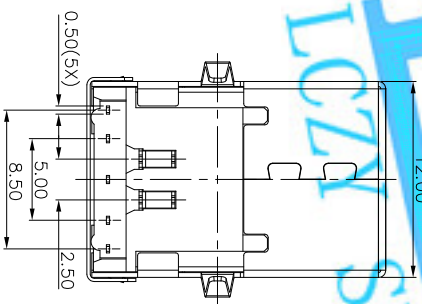
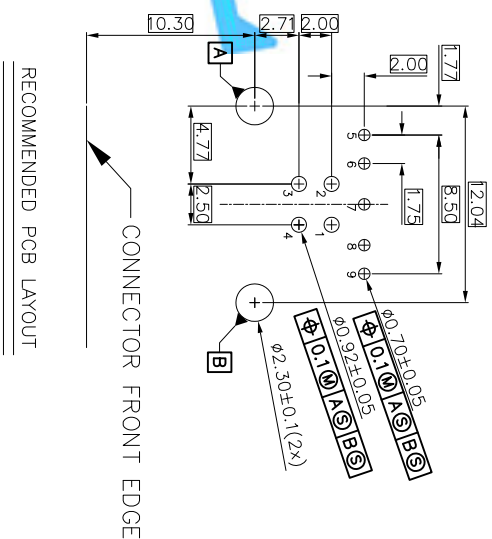
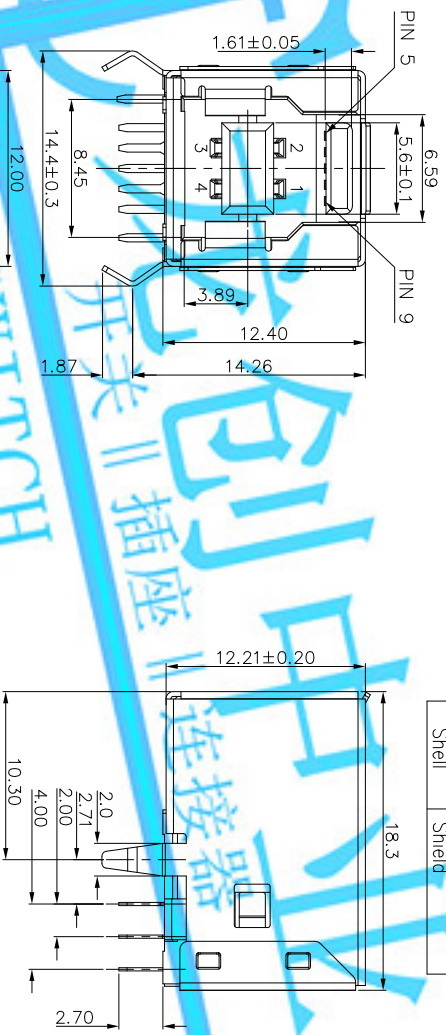


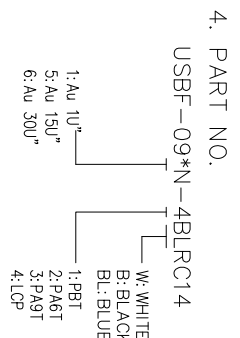
PIN NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	STDA_SSTX-
6	STDA_SSTX+
7	GND_DRAIN
8	STDA_SSRX-
9	STDA_SSRX+
Shell	Shield



Bill of materials:

5	HOUSING	LCP + 30%GF	1	UL94V-0	X: ±0.35	X': ±2"	UNITS	LONGCHUANG ZHONGYE (HK)CO.,LIMITED						
4	BACK COVER	COPPER ALLOY/SPCC	1	PLATED NICKEL	X: ±0.3	X': ±1"	MAT'L	TITLE:	USB3.0 BF 90° DIP 弯脚 H12.4					
					SEE NOTE	PART NO.:	USBF-09XN-4BLRC14							
3	SHELL	COPPER ALLOY	1	PLATED NICKEL	.XX ±0.25	.XX'	SEE NOTE							
2	TERMINAL(4P)	COPPER ALLOY	4	PLATED GOLD/TIN	.XXX ±0.15	.XXX'	FINISH	SEE NOTE	DR: Study 2019/02/15					
					DWG NO.:	All-RC14								
1	TERMINAL(5P)	COPPER ALLOY	5	PLATED GOLD/TIN	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF ACCURATE INNOTECH INC. AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE WRITTEN CONSENT OF ACCURATE INNOTECH INC.			Q'TY	CHKD: Study 2019/02/15	SCALE		SHEET	REV.	CUSTOMER DRAWING
NO	PARTS	MATERIAL	QTY	FINISHING					APPD:	1:1	1/1	B		

- NOTES:
1. ELECTRICAL:
- 1) CURRENT RATING:1.5AMP.
 - 2) INSULATION RESISTANCE: 100MΩ MIN;
 - 3) CONTACT RESISTANCE: 30mΩ MAX;
 - 4) WITHSTANDING VOLTAGE: 100V AC;
 - 5) OPERATING TEMPERATURE: -40℃ TO +85℃.
2. Mechanical:
- 1) Mating Force: 35N MAX
 - 2) Unmating Force: 10N MIN.
3. DIMENSIONS MARKED "▲" TO BE CHECKED BY Q.C & IPQC.



REV.	ECN.	NO.	APPD.